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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO
09 963,493	09-27/2001	Arthur Allan Bayot	TI-33474 (032350.B352)	8827
23494 7	7590 01/30/2003			
TEXAS INSTRUMENTS INCORPORATED			EXAMINER	
P O BOX 6554 DALLAS, TX		COLEMAN, WILLIAM		WILLIAM D
			ART UNIT	PAPER NUMBER
			2823	

DATE MAILED: 01-30-2003

Please find below and/or attached an Office communication concerning this application or proceeding.

Office Action Summary		Application No. Applicant(s)					
		09/963,493	BAYOT, ARTHUR ALLAN				
	Office Action Summary	Examiner	Art Unit				
The MAIL INC DATE And		W. David Coleman	2823				
Period fe	The MAILING DATE of this communication app or Reply	ears on the cover sheet with the o	correspondence address				
- External e	IORTENED STATUTORY PERIOD FOR REPLY MAILING DATE OF THIS COMMUNICATION. nsions of time may be available under the provisions of 37 CFR 1 13 SIX (6) MONTHS from the mailing date of this communication. e period for reply specified above is less than thirty (30) days, a reply period for reply is specified above, the maximum statutory period we are to reply within the set or extended period for reply will, by statute, reply received by the Office later than three months after the mailing and patent term adjustment. See 37 CFR 1 704(b).	within the statutory minimum of thirty (30) day ill apply and will expire SIX (6) MONTHS from	nely filed s will be considered timely. the mailing date of this communication				
Status	Daniel						
	1) Responsive to communication(s) filed on <u>13 January 2003</u> .						
2a)		s action is non-final.					
3) Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213. Disposition of Claims							
4) Claim(s) 1-11 is/are pending in the application.							
4a) Of the above claim(s) <u>5-11</u> is/are withdrawn from consideration.							
5) Claim(s) is/are allowed.							
6)[-	6)⊡ Claim(s) <u>1-5</u> is/are rejected.						
7) Claim(s) is/are objected to.							
8)	8) Claim(s) are subject to restriction and/or election requirement.						
Application Papers							
9)☐ The specification is objected to by the Examiner.							
10)☐ The drawing(s) filed on is/are: a)☐ accepted or b)☐ objected to by the Examiner.							
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a)							
11)[] [11) ☐ The proposed drawing correction filed on is: a) ☐ approved b) ☐ disapproved by the Examiner.						
10\F	If approved, corrected drawings are required in reply to this Office action.						
	he oath or declaration is objected to by the Exar	miner.					
	nder 35 U.S.C. §§ 119 and 120						
13) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).							
a)[_	a) ☐ All b) ☐ Some * c) ☐ None of:						
1	1. Certified copies of the priority documents have been received.						
	2. Certified copies of the priority documents have been received in Application No						
	B. Copies of the certified copies of the priority application from the International Burea se the attached detailed Office action for a list of	9H (PCT Rule 17 2/a))					
14) Acknowledgment is made of a claim for domestic priority under 35 U.S.C. § 119(e) (to a provisional application).							
a) The translation of the foreign language provisional application has been received. 15) Acknowledgment is made of a claim for domestic priority under 35 U.S.C. §§ 120 and/or 121.							
Attachment(s	5)	33 .200					
2) Notice of 3) Informa	of References Cited (PTO-892) of Draftsperson's Patent Drawing Review (PTO-948) tion Disclosure Statement(s) (PTO-1449) Paper No(s)	5) Notice of Information	PTO-413) Paper No(s) lent Application (PTO-152)				
S Patent and Trade TO-326 (Rev	Patent and Trademark Office O-326 (Rev. 04-01) Office Action Summary						

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DETAILED ACTION

Election/Restrictions

1. Applicant's election without traverse of group I invention, claims 1-5 in Paper No. 5 is acknowledged.

Claim Rejections - 35 USC § 102

2. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.
- 3. Claim 1 is rejected under 35 U.S.C. 102(b) as being anticipated by Chapman et al., U.S. Patent 6,059,172.
- 4. <u>Chapman</u> discloses a semiconductor process as claimed. See **FIG. 5**, where <u>Chapman</u> teaches a method of manufacturing a ball grid array semiconductor package comprising the steps of:

providing a substrate 10, wherein said substrate comprises a first surface and a second surface and said first surface or said second surface comprises a conductor pattern;

providing a plurality of conductive bump contact areas **9** on said first surface of said substrate;

substantially aligning each of said conductive bump contact areas with at least one conductive bump 6, wherein the step of substantially aligning said conductive bump contact areas with at least one of said conductive bumps comprises the step of vibrating at least a portion

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of said substrate, wherein said vibration of at least a portion of said substrate substantially aligns each of said conductive bump contact areas with at least one of said conductive bumps; and

disposing at least one of said conductor bumps on each of said conductive bump contact areas (column 2, lines 24-39).

Claim Rejections - 35 USC § 103

- 5. Claims 2, 3, 4 and 5 rejected under 35 U.S.C. 103(a) as being unpatentable over Chapman et al., U.S. Patent 6,059,172 as applied to claim 1 above, and further in view of Kuroda et al., U.S. Patent 5,205,032.
- 6. Pertaining to claim 2, <u>Chapman</u> fails to teach the method of claim 1, wherein the step of vibrating at least a portion of said substrate comprises the step of ultrasonically vibrating at least a portion of said substrate. <u>Kuroda</u> teaches wherein the vibration comprises ultrasonic vibration. In view of <u>Kuroda</u>, it would have been obvious to one of ordinary skill in the art to incorporate ultrasonic vibration into the <u>Chapman</u> semiconductor process because ultrasonic vibration is a comprises a electromagnetic vibrating element (column 3, lines 65-68).
- 7. Pertaining to claim 3, Chapman in view of <u>Kuroda</u> teaches the method of claim 2, wherein the step of ultrasonically vibrating at least a portion of

said substrate comprises the step of ultrasonically vibrating a first end, a second end, and a third end of a film strip on which at least one of said substrates is disposed. In view of <u>Kuroda</u>, it would have been obvious to one of ordinary skill in the art to incorporate ultrasonic vibration into the <u>Chapman</u> semiconductor process because ultrasonic vibration is a comprises a electromagnetic vibrating element (column 3, lines 65-68).

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- 8. Pertaining to claim 4. <u>Chapman</u> in view of <u>Kuroda</u> teaches the method of claim 2, further comprising the step of discontinuing said ultrasonic vibration of at least a portion of said substrate when each of said conductive bump contact areas are substantially aligned with at least one of said conductive bumps. In view of <u>Kuroda</u>, it would have been obvious to one of ordinary skill in the art to incorporate ultrasonic vibration into the <u>Chapman</u> semiconductor process because ultrasonic vibration is a comprises a electromagnetic vibrating element (column 3, lines 65-68).
- 9. Pertaining to claim 5, Chapman in view of Kuroda teaches the method of claim 4, wherein said conductive bumps comprise solder.

Conclusion

10. Any inquiry concerning this communication or earlier communications from the examiner should be directed to W. David Coleman whose telephone number is 703-305-0004. The examiner can normally be reached on 9:00 AM-5:00 PM.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Olik Chaudhuri can be reached on 703-306-2794. The fax phone numbers for the

Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the receptionist whose telephone number is 703-308-0956.

W. David Coleman

Examiner Art Unit 2823

WDC January 25, 2003